



Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
30V	1.5Ω @ V _{GS} = 4.5V	0.40A
	2.0Ω @ V _{GS} = 2.5V	0.35A
	3.0Ω @ V _{GS} = 1.8V	0.28A
	4.5Ω @ V _{GS} = 1.5V	0.23A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch

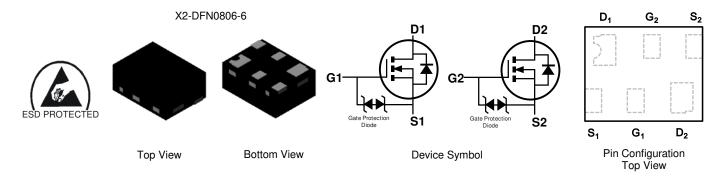
Features and Benefits

- Low On-Resistance
- Very Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 0.8mm x 0.6mm
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- The DMN31D5UDAQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Case: X2-DFN0806-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.001 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN31D5UDAQ-7B	X2-DFN0806-6	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



B7 = Product Type Marking Code

Top View



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 5) V_{GS} = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	0.4 0.32	A
Maximum Continuous Body Diode Forward Current (Note 6)			ls	0.8	А
Pulsed Drain Current (Note 6)			I _{DM}	0.8	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	PD	0.37	W	
Thermal Resistance, Junction to Ambient (Note 5) Steady State		R _{0JA}	339	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
DFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	—		V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current @ $T_C = +25^{\circ}C$	I _{DSS}		—	100	nA	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	—	±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.4	_	1.0	V	$V_{DS}=V_{GS},\ I_{D}=250\mu A$
		_	1.2	1.5	Ω	$V_{GS} = 4.5V, I_D = 100mA$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.3	2.0		$V_{GS} = 2.5V, I_D = 50mA$
Static Drain-Source On-Resistance		_	1.5	3.0		$V_{GS} = 1.8V, I_D = 20mA$
		_	1.8	4.5		$V_{GS} = 1.5V, I_D = 10mA$
Diode Forward Voltage		_	0.6	1.0	V	$V_{GS} = 0V, I_{S} = 10mA$
DYNAMIC CHARACTERISTICS (Note 8)	Diode Forward Voltage V _{SD} — 0.6 1.0 V V _{GS} = 0V, I _S = 10mA DYNAMIC CHARACTERISTICS (Note 8)					
Input Capacitance			22.6		pF	
Output Capacitance			2.68		pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	1.8	_	pF	
Total Gate Charge		_	0.38	_	nC	
Gate-Source Charge		_	0.05	_	nC	V _{GS} = 4.5V, V _{DS} = 15V, I _D = 200mA
Gate-Drain Charge	Q _{gd}	_	0.07	—	nC	
Turn-On Delay Time	t _{D(ON)}	_	3.2	_	ns	
Turn-On Rise Time	t _R		2.2	_	ns	V _{DD} = 15V, V _{GS} = 4.5V,
Turn-Off Delay Time Turn-Off Fall Time		_	21	_	ns	$R_G = 2\Omega, I_D = 200 \text{mA}$
		_	7.5	_	ns	

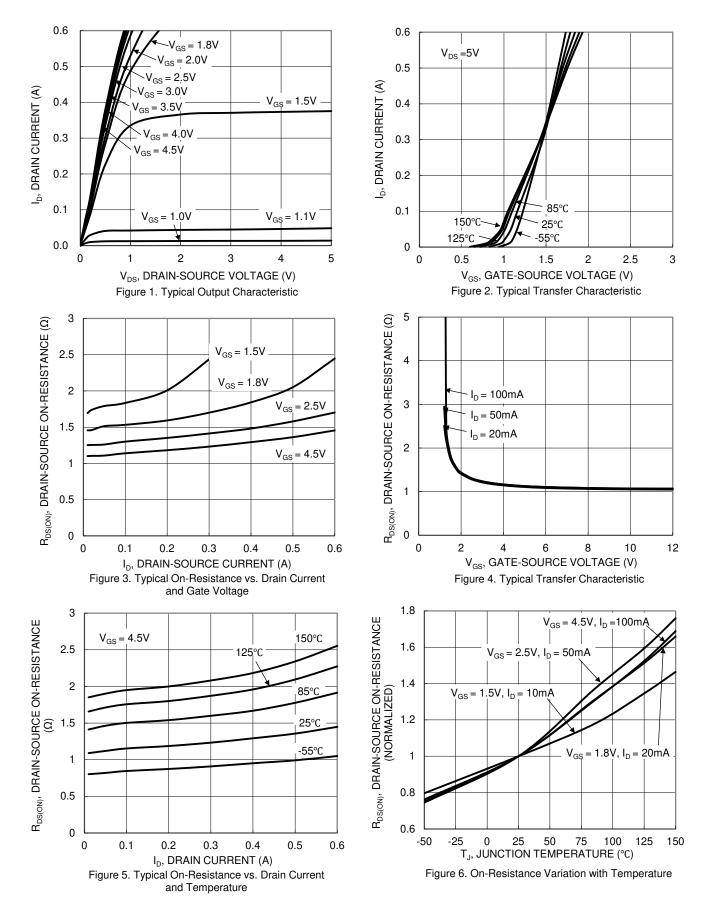
5. Device mounted on FR-4 PCB, with minimum recommended pad layout. Notes:

6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing.

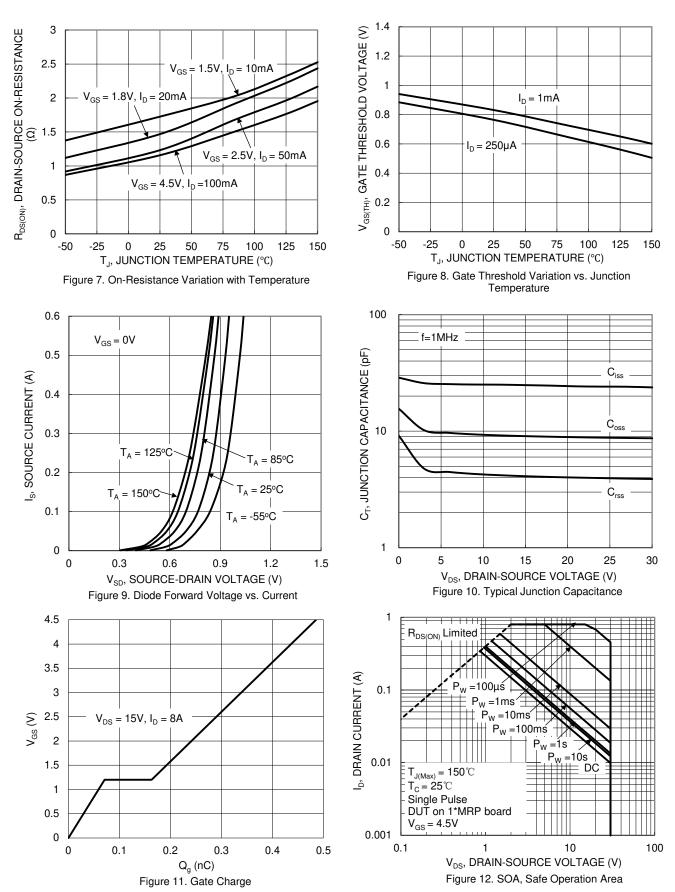
DMN31D5UDAQ



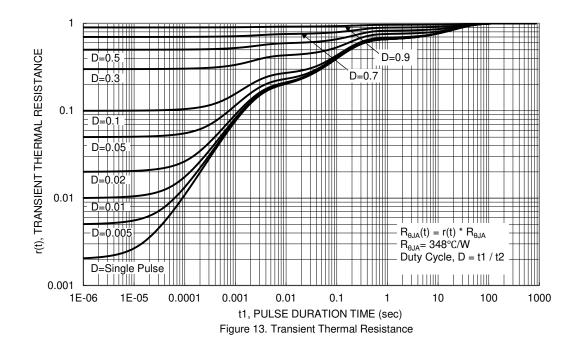


DMN31D5UDAQ Document number: DS42857 Rev. 2 - 2





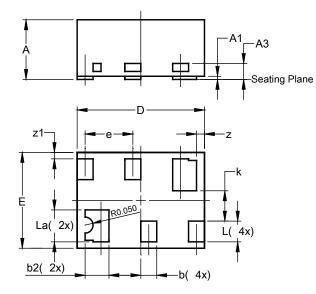






Package Outline Dimensions

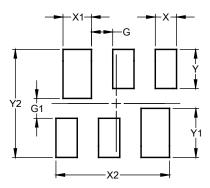
Please see http://www.diodes.com/package-outlines.html for the latest version.



	X2-DFN0806-6						
Dim	Min	Max	Тур				
Α		0.40	0.36				
A1	0.00	0.03	0.02				
A3			0.10				
b	0.07	0.15	0.10				
b2	0.10	0.20	0.15				
D	0.75	0.85	0.80				
E	0.55	0.65	0.60				
е			0.30				
k			0.19				
L	0.10	0.18	0.13				
La	0.17	0.25	0.20				
z			0.05				
z1			0.04				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
G	0.150			
G1	0.140			
X	0.150			
X1	0.200			
X2	0.800			
Y	0.275			
Y1	0.345			
Y2	0.760			



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